**TOSHIBA** SSM3J05FU

TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE

# S S M 3 J 0 5 F U

POWER MANAGEMENT SWITCH

Unit in mm

HIGH SPEED SWITCHING APPLICATIONS

Small Package

Low on Resistance :  $R_{on} = 3.3 \Omega \text{ Max.} (@V_{GS} = -4 \text{ V})$ 

:  $R_{on} = 4.0 \Omega \text{ Max.} (@V_{GS} = -2.5 \text{ V})$ 

Low Gate Threshold Voltage

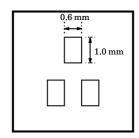
## MAXIMUM RATINGS (Ta = 25°C)

<b>,</b>	SYMBOL			
CHARACTERISTIC			UNIT	
Drain-Source Voltage			V	
Gate-Source Voltage			V	
DC	$I_{\mathrm{D}}$	-200	mA	
Pulse	$I_{\mathrm{DP}}$	-400		
Drain Power Dissipation (Ta = 25°C)			mW	
Channel Temperature			°C	
Storage Temperature Range			°C	
	DC Pulse a = 25°C)	$\begin{array}{c c} & V_{DS} \\ \hline & V_{GSS} \\ \hline DC & I_D \\ \hline Pulse & I_{DP} \\ a = 25 ^{\circ}C) & P_D^* \\ \hline & T_{ch} \\ \hline \end{array}$	$\begin{array}{c cccc} & V_{DS} & -20 \\ & V_{GSS} & \pm 12 \\ \hline DC & I_D & -200 \\ Pulse & I_{DP} & -400 \\ a = 25^{\circ}C) & P_{D}^{*} & 150 \\ & T_{ch} & 150 \\ \hline \end{array}$	

 $2.1 \pm 0.1$ 1.25 ± 0.1 2.0 ± 0.2  $0 \sim 0.1$ : GATE **SOURCE** 3 : DRAIN **USM JEDEC** EIAJ SC-70 TOSHIBA 2-2E1E

Weight: 0.006 g (Typ.)

\* Mounted on FR4 board.  $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad} : 0.6 \text{ mm}^2 \times 3)$ 



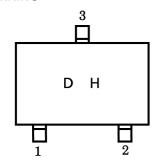
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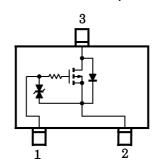
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#### **MARKING**



## **EQUIVALENT CIRCUIT (TOP VIEW)**



#### HANDLING PRECAUTION

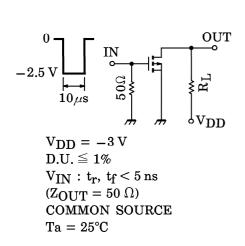
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

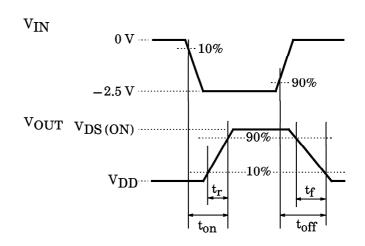
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARAC	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	Current	$I_{GSS}$	$V_{GS} = \pm 12  V,  V_{DS} = 0$	_	_	±1	$\mu$ A
Drain-Source Breakdown Voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20	_	_	V
Drain Cut-off	Current	$I_{ m DSS}$	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	_	_	-1	$\mu$ A
Gate Threshol	ld Voltage	$ m V_{th}$	$V_{DS} = -3 V, I_{D} = -0.1 mA$	-0.6	_	-1.1	V
Forward Tran Admittance	sfer	Y <sub>fs</sub>	$V_{DS} = -3 \text{ V}, I_D = -50 \text{ mA}$ (Note)	100	_	_	mS
Drain-Source ON Resistance		R <sub>DS</sub> (ON)	$I_D = -100 \text{ mA}, V_{GS} = -4 \text{ V}$ (Note)	_	2.1	3.3	- Ω
			$I_{D} = -50 \text{ mA}, V_{GS} = -2.5 \text{ V}$ (Note)	_	3.2	4.0	
Input Capacit	ance	$C_{iss}$	$V_{DS} = -3 \text{ V}, V_{GS} = 0,$ f = 1 MHz	_	27	_	pF
Reverse Trans Capacitance	sfer	$\mathrm{C}_{\mathrm{rss}}$	$egin{aligned} V_{ m DS} = -3  V,  V_{ m GS} = 0, \\ f = 1  { m MHz} \end{aligned}$		7	_	pF
Output Capac	itance	$C_{oss}$	$V_{DS} = -3 \text{ V}, V_{GS} = 0,$ f = 1 MHz		21		pF
Switching	Turn-on Time	t <sub>on</sub>	$V_{DD} = -3 \text{ V}, I_{D} = -50 \text{ mA},$		70		ng
Time	Turn-off Time	${ m t_{off}}$	$V_{GS} = 0 \sim -2.5 \text{ V}$	_	70	_	ns

(Note): Pulse test

## SWITCHING TIME TEST CIRCUIT





#### **PRECAUTION**

 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D = -100 \,\mu\text{A}$  for this product. For normal switching operation,  $V_{GS\,(on)}$  requires higher voltage than  $V_{th}$  and  $V_{GS\,(off)}$  requires lower voltage than  $V_{th}$ .

(Relationship can be established as follows:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ )

Please take this into consideration for using the device.

VGS recommended voltage of -2.5 V or higher to turn on this product.

